503960921 08/15/2016

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHUN-HAO CHOU	06/20/2014
YIN-CHIEH HUANG	06/20/2014
KUO-CHENG LEE	06/20/2014
CHI-CHERNG JENG	06/20/2014
HSIN-CHI CHEN	06/20/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15237289

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	24061.2681US03
NAME OF SUBMITTER:	LINDA INGRAM
SIGNATURE:	/Linda Ingram/
DATE SIGNED:	08/15/2016

PATENT 503960921 REEL: 039437 FRAME: 0694

Total Attachments: 3

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PATENT REEL: 039437 FRAME: 0695

Docket No.: 2013-1311 / 24061.2681

Customer No.: 000042717

ASSIGNMENT

WH	ER	EΑ	S,	we
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(1)	Chun-Hao Chou	of	No. 8, Lane 156, Wenhua 1st Street East District, Tainan City 701 Taiwan R.O.C.
(2)	Yin-Chieh Huang	of	No. 70, Lane 439, Zhongzheng Road Xinying District, Tainan City 730 Taiwan R.O.C.
(3)	Kuo-Cheng Lee	of	No. 31, Dongqiao 8th Street Yongkang District Tainan City 710, Taiwan R.O.C.
(4)	Chi-Cherng Jeng	of	No. 326, Keziliao, Madou Township Tainan County 721, Taiwan R.O.C.
(5)	Hsin-Chi Chen	of	No. 51, Lane 239, Dingmei 3rd Street West Central District Tainan City 700, Taiwan R. O. C.

have invented certain improvements in

STRUCTURE OF DIELECTRIC GRID FOR A SEMICONDUCTOR DEVICE

for which we have executed an application for Letters Patent of the United States of America,

of even date filed herewith; and
filed on November 25, 2013, and assigned application number 14/088,957; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent

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application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Chun-Hao Chou	
Residence Address:	No. 8, Lane 156, Wenhua 1st St Tainan City 701, Taiwan, R.O.C	reet, East District
Dated: 2014 06	. 20	Chun - Hao Chan Inventor Signature
Inventor Name:	Yin-Chieh Huang	
Residence Address:	No. 70, Lane 439, Zhongzheng Xinying District, Tainan City 73	30, Taiwan, R.O.C.
Dated: WIY	6.2	In-chieh Huana Inventor Signature
Inventor Name:	Kuo-Cheng Lee	
Residence Address:	No. 31, Dongqiao 8th Street Yongkang District, Tainan City	710, Taiwan R.O.C.
Dated: >0/4. 6	, , >0	Kun - Clary Lel Inventor Signature

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Inventor Signature

Inventor Name:

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Dated: 204 6 20

Inventor Signature

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RECORDED: 08/15/2016